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I hereby certify that this correspondence is being deposited on January 14, 1998 with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231.

Cheryle A. Healion

PATENT Docket No. 420099-654 LSI Ref. P-2880/1D

> H3 IDS 2-18-98

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Mike Liang

Serial No.: 08/909,312

Filed: August 14, 1997

Entitled: **METHOD FOR**

DISTRIBUTING CONNECTION PADS

ON A SEMICONDUCTOR DIE

(As Amended)

Group Art Unit: 1104

Examiner:

JEOF 1998

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Assistant Commissioner for Patents Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:

Submitted herewith are one sheet of Form PTO-1449 and one copy of each of the patent documents listed therein for the above-captioned divisional application.

It is respectfully requested that the Examiner make his consideration of each of these documents formally of record with his initial action.

PATENTDocket No. 420099-654 LSI Ref. P-2880/1D

If any fees are due with this Information Disclosure Statement, the Commissioner is authorized to charge them to Deposit Account Number 16-2230.

Respectfully submitted,

Dated: January 14, 1998

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